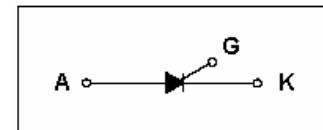


Silicon Controlled Rectifier

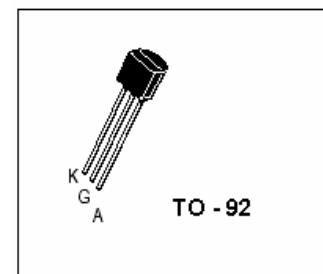
■ Features

- * Repetitive Peak Off-State Voltage : 600V
- * R.M.S On-State Current($I_{T(RMS)}=1.5A$)
- * Low On-State Voltage (1.2V(Typ.))@ I_{TM}



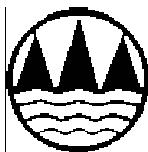
■ General Description

Sensitive triggering SCR is suitable for the application where gate current limited such as small motor control, gate driver for large SCR, sensing and detecting circuits.



■ Absolute Maximum Ratings ($T_a=25^\circ C$ unless otherwise specified)

T_{stg} —— Storage Temperature	—40~125 °C
T_j —— Operating Junction Temperature	—40~125 °C
V_{DRM} —— Repetitive Peak Off-State Voltage	600V
IT (RMS) —— R.M.S On-State Current (180° Conduction Angles)	1.5A
$I_{T(AV)}$ —— Average On-State Current (Half Sine Wave : $T_C = 45^\circ C$)	1.0A
IT_{SM} —— Surge On-State Current (1/2 Cycle, 60Hz, Sine Wave, Non-repetitive)	15A
I^2t —— Circuit Fusing Considerations($t = 8.3ms$)	0.9A ² s
P_{GM} —— Forward Peak Gate Power Dissipation ($T_a=25^\circ C$)	2W
$P_{G(AV)}$ —— Forward Average Gate Power Dissipation ($T_a=25^\circ C$, $t=8.3ms$)	0.1W
I_{FGM} —— Forward Peak Gate Current	1A
V_{RGM} —— Reverse Peak Gate Voltage	5V



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HCR2C60

■ Electrical Characteristics ($T_a=25^\circ\text{C}$ unless otherwise specified)

Symbol	Items	Min.	Typ.	Max.	Unit	Conditions
I_{DRM}	Repetitive Peak Off-State Current			10 200	uA	$V_{AK}=V_{DRM}$ $T_a=25^\circ\text{C}$ $T_a=125^\circ\text{C}$
V_{TM}	Peak On-State Voltage (1)		1.2	1.7	V	$I_{TM}=3\text{A,PEAK}$
I_{GT}	Gate Trigger Current (2)			200 500	uA	$V_{AK}=6\text{V(DC)}$, $R_L=100\text{ ohm}$ $T_a=25^\circ\text{C}$ $T_a=-40^\circ\text{C}$
V_{GT}	Gate Trigger Voltage (2)			0.8 1.2	V	$V_{AK}=7\text{V(DC)}$, $R_L=100\text{ ohm}$ $T_a=25^\circ\text{C}$ $T_a=-40^\circ\text{C}$
V_{GD}	Non-Trigger Gate Voltage	0.2			V	$V_{AK}=12\text{V}$, $R_L=100\text{ ohm}$ $T_a=125^\circ\text{C}$
I_H	Holding Current		2.0	5.0 10	mA	$I_T=100\text{mA}$, Gate open, $T_a=25^\circ\text{C}$ $T_a=-40^\circ\text{C}$
$R_{th(j-c)}$	Thermal Resistance			50	°C/W	Junction to Case
$R_{th(j-a)}$	Thermal Resistance			160	°C/W	Junction to Ambient
dv/dt	Critical Rate of Rise Off-state Voltage	200			V/μs	$V_D=V_{DRM}67\%$ exponential Waveform $R_{jk}=1\text{Kohm}$ $T_j=125^\circ\text{C}$

- Forward current applied for 1 ms maximum duration,duty cycle $\leqslant 1\%$.
- R_{GK} current is not included in measurement.

■ Performance Curves

FIGURE 1 – Gate Characteristics

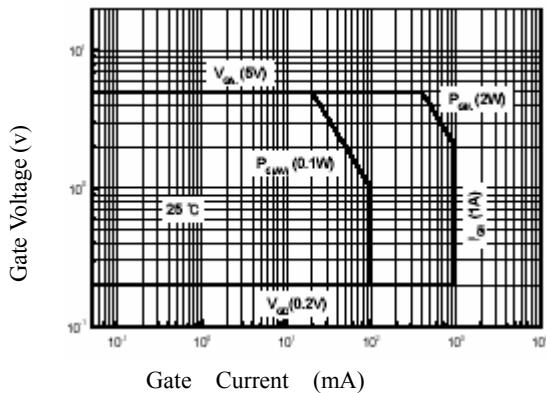
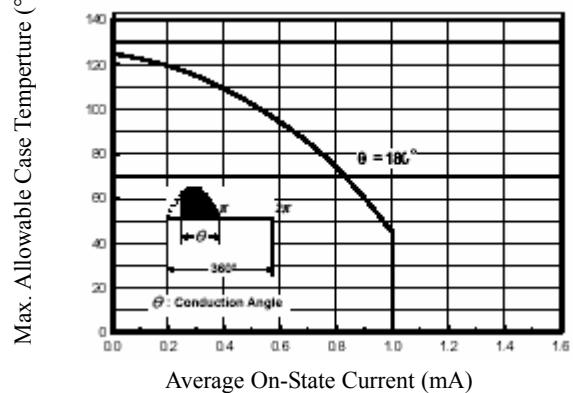
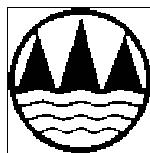


FIGURE 2 – Maximum Case Temperature





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FIGURE 3-Typical Forward Voltage(V)

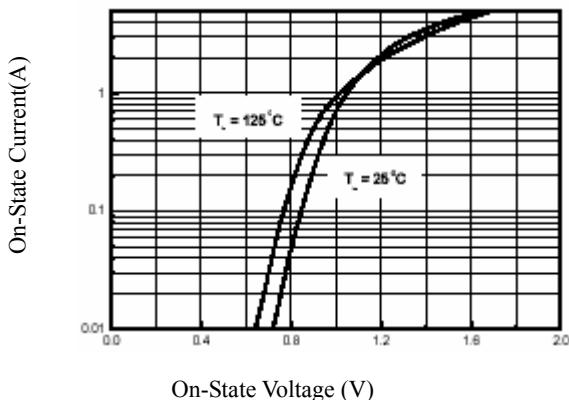


FIGURE 4-Thermal Response

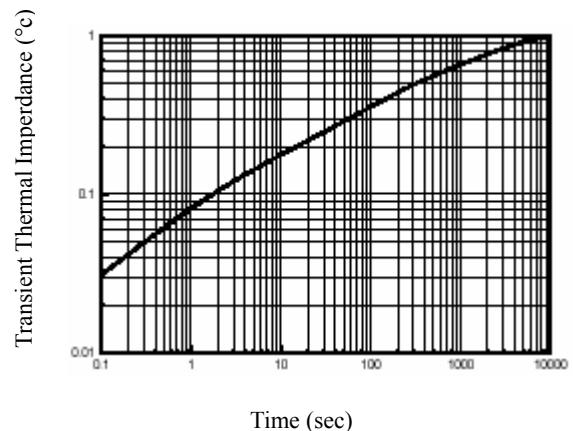


FIGURE 5-Typical Gate Trigger Voltage VS Junction Temperature

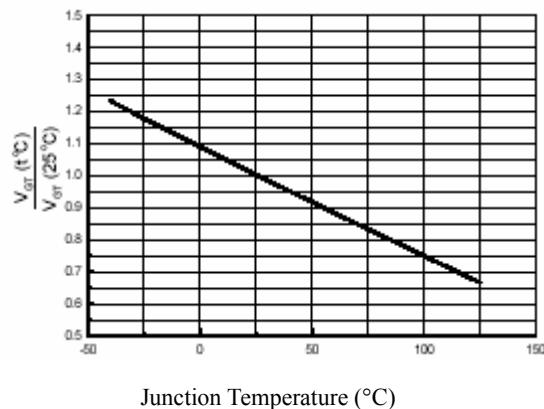


FIGURE 6-Typical Gate Trigger Current VS Junction Temperature

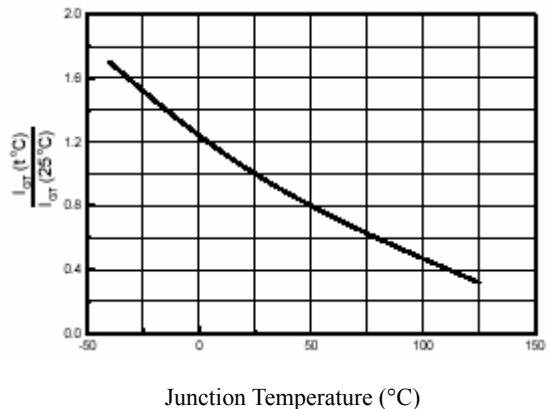


FIGURE 7-Typical Holding Current

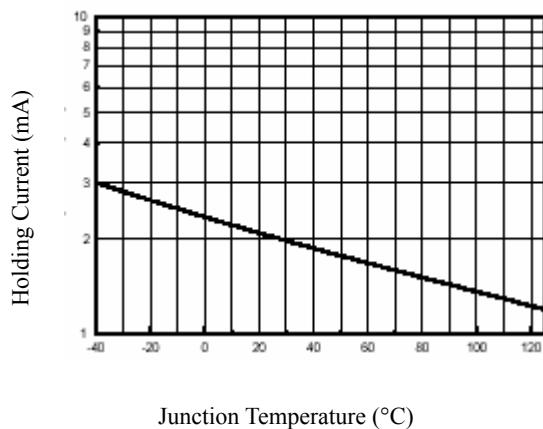


FIGURE 8-Power Dissipation

